Philips Components-Signetics

Document No.	853-0153
ECN No.	86487
Date of Issue	November 11, 1986
Status	Product Specification
Memory Produ	icts

DESCRIPTION

The organization of this device allows byte storage of data, including parity. Where parity is not monitored, the ninth bit can be used as a tag or status indicator for each word stored. Ideal for scratch pad, push down stacks, buffer memories, and other internal memory applications in which cost and performance requirements dictate a wide data path in favor of word depth.

The 82S09/09A features Open-Collector outputs, Chip Enable input, and a very low current PNP input structure to enhance memory expansion.

Ordering codes are listed in the Ordering Information Table.

The 82S09 and 82S09A devices are also processed to military requirements for operation over the military temperature range. For specifications and ordering information consult the Signetics Military Data Handbook.

BLOCK DIAGRAM

82S09 82S09A 576-bit TTL bipolar RAM

FEATURES

Address access time:

- N82S09: 45ns max
- NB2S09A: 35ns max
- Write cycle time:
- N82S09/09A: 45ns max
- Power dissipation: 1.3mW/bit typ
- Input loading: -100µA max
- On-chip address decoding
- Schottky clamped
- Fully TTL ∞mpatible
- Output is non-blanked during Write
- One Chip Enable input
- Outputs: Open-Collector

APPLICATIONS

- Buffer memory
- Control register
- FIFO memory.
- Push down stack
- Scratch pad



+ 01 + 02 + 03 + 04 + 05 + 06 + 07 + 08 OUTPUT BUFFER 16 × 36 MATRIX 1:16 DECODER ADDRESS BUFFER SENSE A4 A5 Ю 9:36 MUX ۵ 12 13 ONTROI 13 0 14 0 15 0 16 0 17 0 18 0 INPUT BUFFEF WRITE AMPL O WE о СЕ

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Product Specification

576-bit TTL bipolar RAM (64×9)

82S09 / 82S09A

ORDERING INFORMATION

DESCRIPTION	N82S09 N, N82S09A N
28-Pin Plastic Dual-In-Line 600mil-wide	N82S09 N, N82S09A N
28-Pin Plastic Leaded Chip Carrier 450mil-square	N82S09 A, N82S09A A

ABSOLUTE MAXIMUM RATINGS

SYMBOL PARAMETER		RATING	UNIT	
Vcc	Supply voltage	+7.0	VDC	
VIN	înput voltage	+5.5	V _{DC}	
VOH Output voltage High		+5.5	V _{DC}	
Tamb Operating temperature range		0 to +75	∿	
T _{stg}	Storage temperature range	65 to +150	°C	

DC ELECTRICAL CHARACTERISTICS 0°C \leq T_{anb} \leq +75°C, 4.75V \leq V_{CC} \leq 5.25V

SYMBOL PARAMETER	PARAMETER	TEST CONDITIONS		LIMITS			
		MIN	ТҮР	MAX			
Input volta	ge ¹						
VIL	Low	V _{CC} = 4.75V			0.8	v	
ViH	High	$V_{CC} = 5.25V$	2.0			v	
Vic	Clamp ²	$V_{CC} = 4.75V$, $ _{IN} = -12mA$			-1.5	v	
Output vol	lage ¹						
VoL	Low ³	$V_{CC} = 4.75V, I_{OL} = 8.0mA$			0.5	v	
Input curre	nt						
կլ	Low	V _{IN} = 0.45V			-100	μA	
IH	High	$V_{IN} = 5.5V$			25	μA	
Output cur	rent						
OLK	Leakage ⁴	V _{CC} = 5.25V, V _{OUT} = 5.5V			40	μA	
Supply cur	rent ⁵						
lcc		V _{CC} = 5.25V			190	mA	
Capacitanc	xe						
		$V_{\rm CC} = 5.0 V$					
CIN	Input	V _{IN} = 2.0V		5		pΕ	
COUT	Output	$V_{OUT} = 2.0V$		В		ρF	

NoTES:
1. All voltage values are with respect to network ground.
2. Test each input one at a time
3. Measured with the logic Low stored. Output sink current is applied through a resistor to V_{CC}.
4. Measured with V_{IH} applied to CE.
5. I_{CC} is measured with the Write Enable and Chip Enable inputs grounded, all other inputs at 0.45V, and the outputs open.
6. The operating ambient temperature ranges are guaranteed with transverse air flow exceeding 400 linear feet per minute and a 2-minute warm-up.

TRUTH TABLE

MODE	CE	WE	ł _N	0 _N
Read	0	1	Х	Stored Data
Write "0"	0	0	0	1
Write "1"	0	0	1	0
Disable	1	x	Х	1

X = Don't care

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AC ELECTRICAL CHARACTERISTICS $R_1 = 600\Omega$, $R_2 = 900\Omega$, $C_L = 30pF_10^\circ C \le T_{amb} \le +75^\circ C$, 4.75V $\le V_{CC} \le 5.25V$

SYMBOL	PARAMETER	то	FROM	N82S09			N82S09A			UNIT
				MIN	ТҮР	MAX	MIN	ТҮР	MAX	
Access time	e								· — — —	
t _{AA}	Address	Output	Address			45			35	ns
tCE	Chip Enable	Output	Output			30			25	ns.
Disable tim	e ¹									
tcp		Output	Chip Enable		1	30			25	ns
twa	Valid time	Output	Write Enable			30			25	ns
Setup and	hold time							·		
twsa ²	Setup time	Write Enable	Address	5			5			ns
twha	Hold time	Write Enable	Address	5			5			ns
Iwsp	Setup time	Write Enable	Data in	35			30			ns
twhD	Hold time	Write Enable	Data in	5			5			ns
twsc	Setup time	Write Enable	CE	5		i	5			ns
twhc	Hold time	Write Enable	CE	5	1		5	1		ns
Pulse wid	ith ³			_	<u>. </u>	•			,	
twp4	Write Enable			35			35			ns



VOLTAGE WAVEFORMS



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